

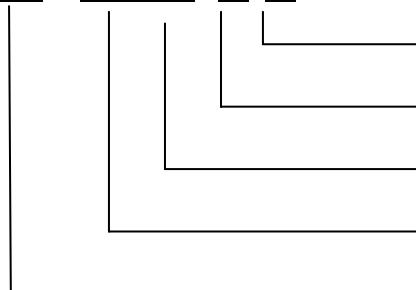
1. 概述 INTRODUCTION

DIP 双工器系列产品由低通滤波器和高通滤波器（或带通滤波器）组成，用于 EPON+EOC 有线电视网络双向改造工程，具有低插入损耗、高隔离度和低反射等特点。能减少复杂的调校工作，可以简化电路设计。

"Group-Tek" DIP Diplexer series is formed with LP and HP (or BPF) to be applied for EPON+EOC CATV bidirectional rebuild Network, with low insertion loss high isolation and low return, which can simplify your complex tuning and circuit design .

2. 型号 Part Number

DIP - 2MLB - 65 87



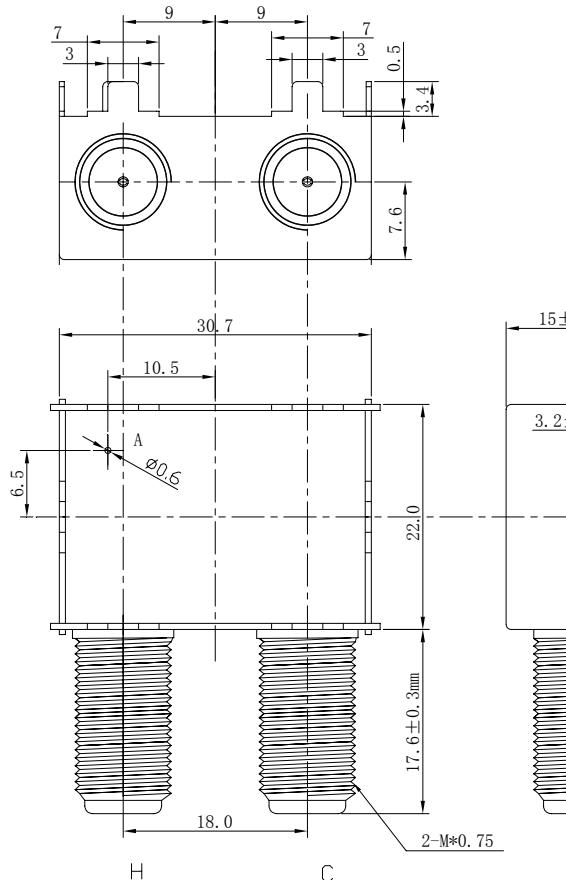
高通频率 High Frequency: 87 ~860MHz

低通频率 Low Frequency: 2 ~65MHz

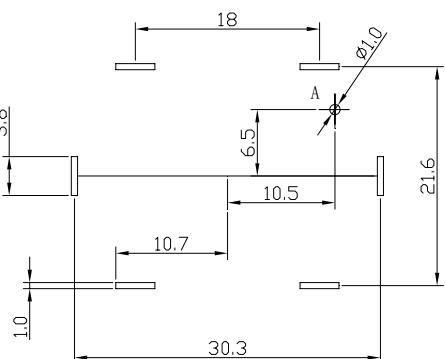
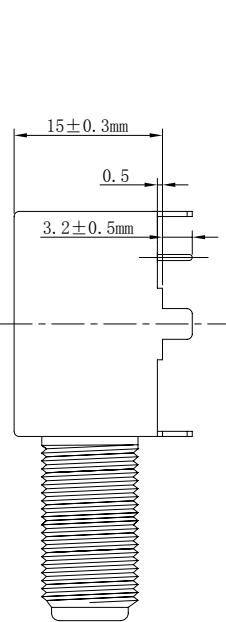
特征序号 Serial number : 1~9 或 A~Z

接头特征 : Connectors : 2 公制 F 头

3. 外型尺寸 Dimension (Unit: mm)

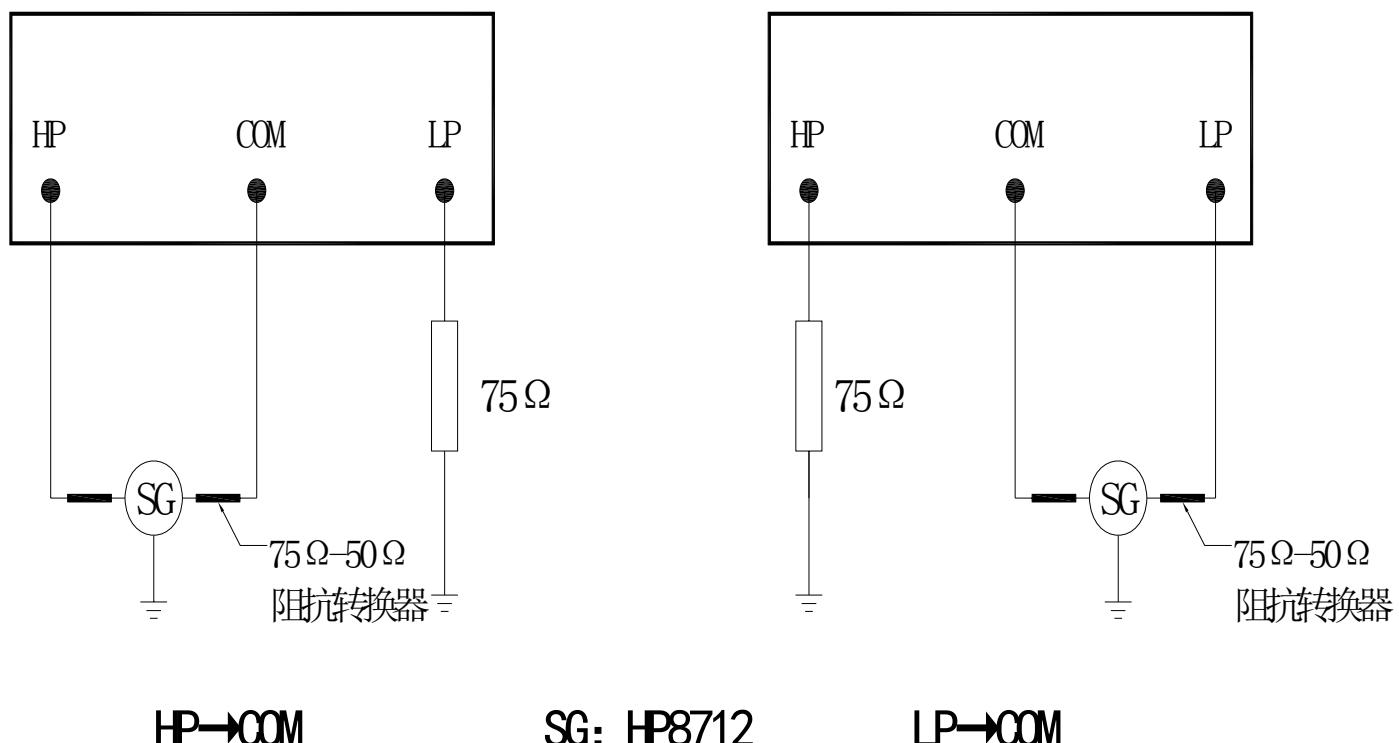


注:
1. A 为LP信号端;
2. F头为公制;
3. 未注公差±0.2mm



建议的客户PCB图

4. 测试电路 Evaluation Board



HP → COM

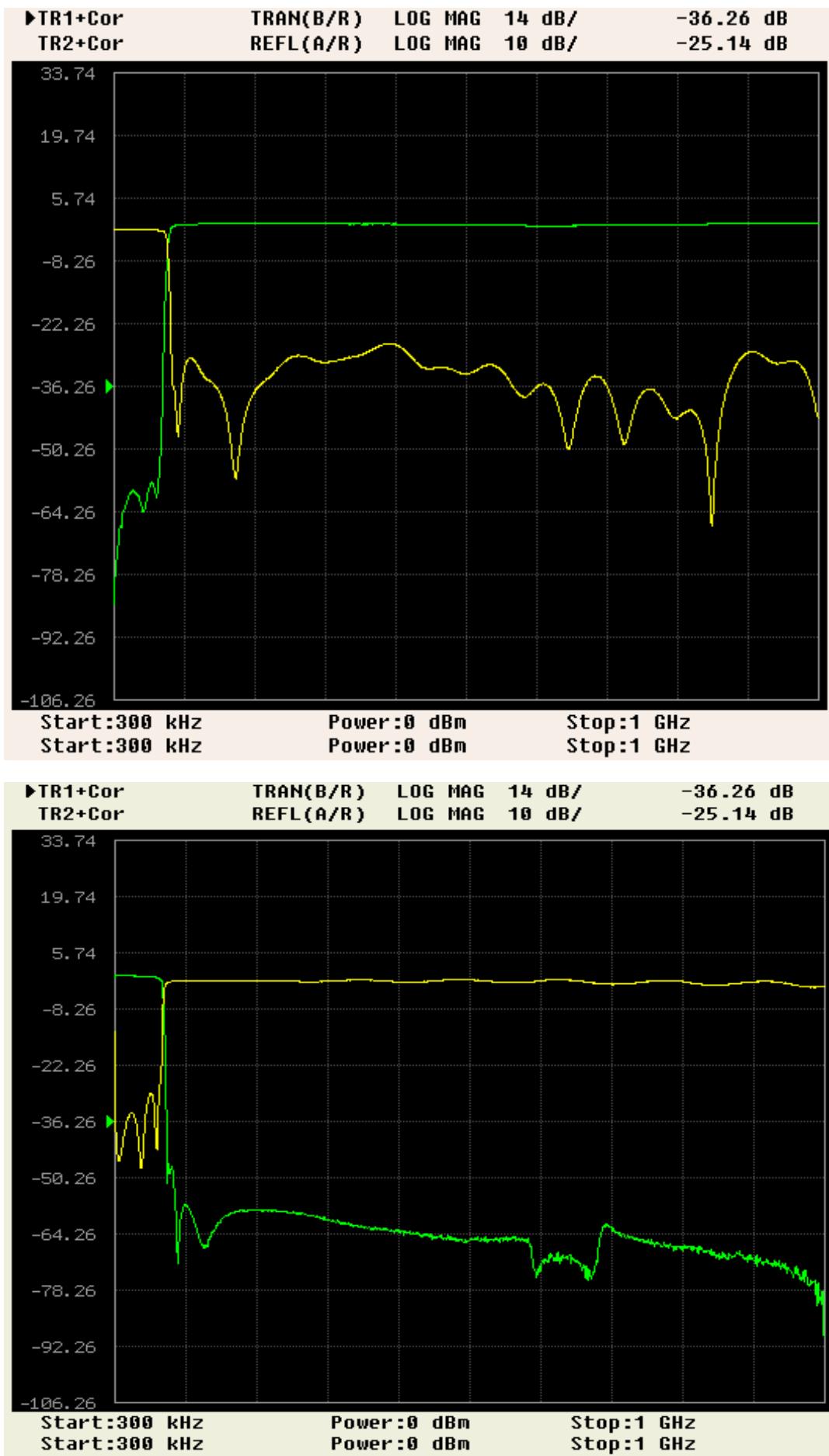
SG: HP8712

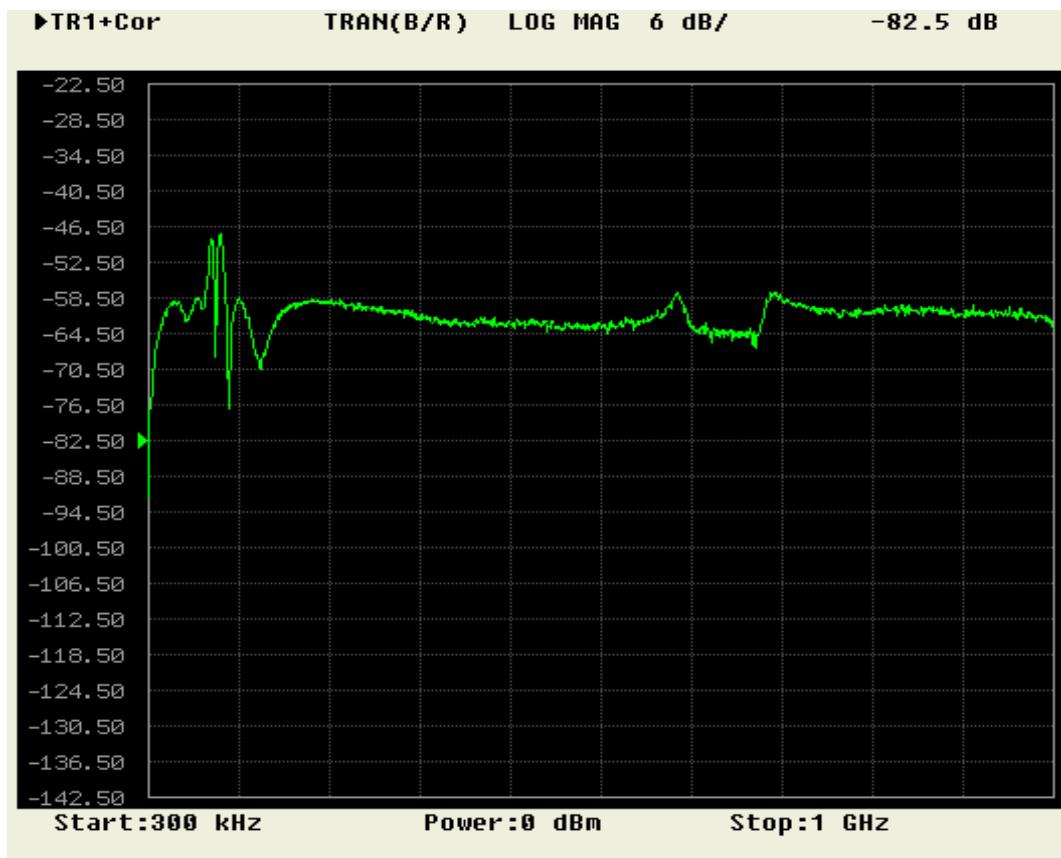
LP → COM

5. 电气性能 Electrical Characteristics

| No | Item (项目) | Specifications (特性) |
|-----|---|---|
| 5.1 | Low Frequency 低通频率 | 2~65 MHz |
| 5.2 | High Frequency 高通频率 | 87~1000MHz |
| 5.3 | Insertion loss 插入损耗 | ≤1.5dB (at 2~65MHz) ≤1.5dB (at 87~1000MHz) |
| 5.4 | LOG Mag 反射 | ≥16dB (at 2~65MHz) ≥16dB (at 87~1000MHz) |
| 5.5 | Attenuation 阻带衰耗 (Absolute value) (绝对值) | ≥50 dB (at 2~65MHz) ≥50 dB (at 87~1000MHz) |
| 5.6 | Isolation 隔离度 | ≥50 dB (at 2~65MHz) ≥50dB (at 87~1000MHz) |
| 5.7 | In/output impedance 输入输出阻抗 | 75 Ω |

6. 特性曲线 Characteristic curve





7. 经环境试验后允许比起始读

| No. | Item (项目) | Post Environmental Tolerance (环境试验后允许附加误差) |
|-----|---------------------|---|
| 7.1 | Insertion Loss 插入衰耗 | ±0.5 dB |
| 7.2 | Ripple (in BW) 通带波动 | ±0.5 dB |
| 7.3 | LOG Mag 反射 | ±2.0 dB |
| 7.4 | Isolation 隔离度 | ±2.0 dB |

数据偏差下表

Post Environmental Tolerance (Refer to the table)

8. 环境试验 Environmental Test

基准条件：温度范围 Temperature range $25\pm5^{\circ}\text{C}$

相对湿度范围 Relative Humidity range 55~75% RH

工作温度 Operating Temperature range $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$

贮藏温度 Storage Temperature range $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$

8.1 耐振动 Vibration Resist

在振动频率为 10~55Hz 振幅为 1.5mm 沿 X.Y.Z 方向各振动 2 小时后测试符合表 7.1~7.4 规定。

The device should satisfy the electrical characteristics specified in paragraph 7.1~7.4 after applied to the vibration of 10 to 55Hz with amplitude of 1.5mm for 2 hours each in

X , Y and Z directions.

8. 2 耐跌落冲击 Drop Shock

在 100cm 高度处按 X , Y , Z 三个面分别自由跌落在木制地板上共 3 次后测试符合表 7.1~7.4 规定。

The device should satisfy the electrical characteristics specified in paragraph 7.1~7.4 after dropping onto the hard wooden board from the height of 100cm for 3 times each facet of the 3 dimensions of the device.

8. 3 耐湿热特性 Moisture Proof

在温度为 $60\pm2^{\circ}\text{C}$, 相对湿度 90~95% 的恒温恒湿箱中放置 96 小时 , 在常温中恢复 1~2 小时后测试 , 符合表 7.1~7.4 规定。

The device should satisfy the electrical characteristics specified in paragraph 7.1~7.4 after exposed to the temperature $60\pm2^{\circ}\text{C}$ and the relative humidity 90~95% RH for 96 hours and 1~2 hours recovery time under normal condition .

8. 4 高温特性 High Temperature Endurance

在温度为 $85\pm5^{\circ}\text{C}$ 的恒温箱中放置 96 ± 2 小时 , 在常温中恢复 1~2 小时后测试。符合表 7.1~7.4 规定。

The device should satisfy the electrical characteristics specified in paragraph 7.1~7.4 after exposed to temperature $85\pm5^{\circ}\text{C}$ for 96 ± 2 hours and 1~2 hours recovery time under normal temperature.

8. 5 低温特性 Low Temperature Endurance

在温度为 $-40^{\circ}\text{C}\pm5^{\circ}\text{C}$ 低温箱中放置 96 ± 2 小时后恢复 1~2 小时测试符合表 7.1~7.4 规定。

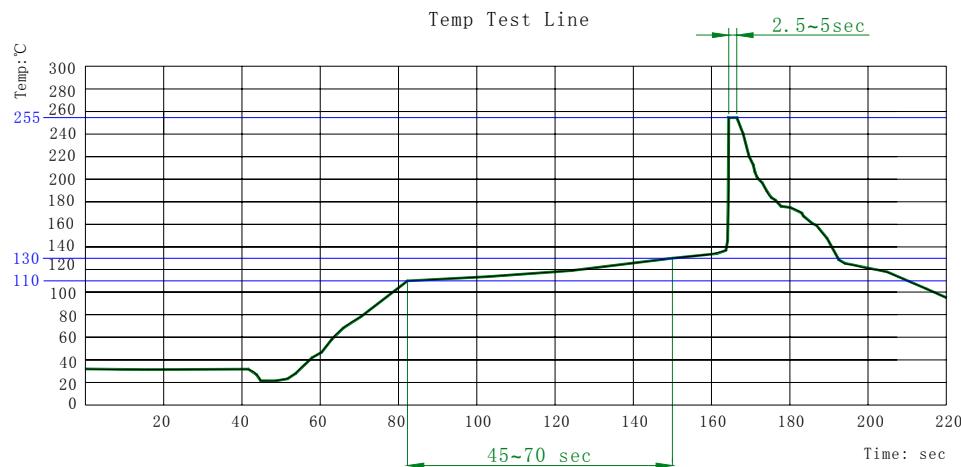
The device should also satisfy the electrical characteristics specified in paragraph 7.1~7.4 after exposed to the temperature $-40^{\circ}\text{C}\pm5^{\circ}\text{C}$ for 96 ± 2 hours and to 2 hours recovery time under normal temperature.

8. 6 温度循环 Temperature Cycle Test

在 -40°C 温度中保持 30 分钟 , 再在 $+85^{\circ}\text{C}$ 温度中保持 30 分钟 , 共循环 5 次后在常温中恢复 1~2 小时后测试符合表 7.1~7.4 规定。

The device should also satisfy the electrical characteristics specified in paragraph 7.1~7.4 after exposed to the low temperature -40°C and high temperature $+85^{\circ}\text{C}$ for 30±2 min each by 5 cycles and 1 to 2 hours recovery time under normal temperature.

8. 8. 波峰焊温度 Wave crest Soldering Standard Condition



注:

1. 预热温度 $110\sim130^{\circ}\text{C}$ 时间为 45~70sec;
2. 焊接温度 255°C 时间为 2.5~5.0sec;

3. 焊料为锡银铜合金。